

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Nadir Sharaf</td> <td>04/16/2012</td> </tr> <tr> <td>Yu Qin</td> <td>04/19/2012</td> </tr> <tr> <td>Reshma Rathod</td> <td>04/16/2012</td> </tr> <tr> <td>Richard J. Hampo</td> <td>04/17/2012</td> </tr> </tbody> </table>		Name	Execution Date	Nadir Sharaf	04/16/2012	Yu Qin	04/19/2012	Reshma Rathod	04/16/2012	Richard J. Hampo	04/17/2012
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<table border="1"> <tr> <td>Name:</td> <td>Lear Corporation</td> </tr> <tr> <td>Street Address:</td> <td>21557 Telegraph Road</td> </tr> <tr> <td>City:</td> <td>Southfield</td> </tr> <tr> <td>State/Country:</td> <td>MICHIGAN</td> </tr> <tr> <td>Postal Code:</td> <td>48033</td> </tr> </table>		Name:	Lear Corporation	Street Address:	21557 Telegraph Road	City:	Southfield	State/Country:	MICHIGAN	Postal Code:	48033
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CORRESPONDENCE DATA											
<p>Fax Number: (248)358-3351</p> <p>Phone: (248) 358-4400</p> <p>Email: apage@brookskushman.com</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Brooks Kushman P.C.</p> <p>Address Line 1: 1000 Town Center</p> <p>Address Line 2: Suite 2200</p> <p>Address Line 4: Southfield, MICHIGAN 48075</p>											
ATTORNEY DOCKET NUMBER:	LEAR 50530 PUS										
NAME OF SUBMITTER:	John R. Buser										
<p>Total Attachments: 2</p> <p>source=assignment#page1.tif</p> <p>source=assignment#page2.tif</p>											

CH \$40.00 13209552

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we, Nadir Sharaf of 5395 Hollow Drive, Bloomfield Township, MI 48302, Yu Qin of 1850 New Castle Drive, Troy, MI 48098, Reshma Rathod of 2845 Tall Oaks Ct., Apt. 23, Auburn Hills, MI 48326, and Richard J. Hampo of 13745 Embers Court, Plymouth, MI 48170, respectively, do hereby assign, sell and set over to Lear Corporation, a corporation organized and existing under the laws of the state of Delaware, and having a place of business at 21557 Telegraph Road, Southfield, Michigan 48033, hereinafter referred to as the ASSIGNEE, its successors, assigns or other legal representatives, the entire right, title and interest, domestic and foreign, in and to the inventions and discoveries in

POWER MODULE COOLING SYSTEM

for which an application for a United States Patent is to be filed or will have been filed on August 15, 2011, as Application Serial No. 13/209,552, including the right of said ASSIGNEE, its successors, assigns or other legal representatives to make applications and to receive Letters Patent for said inventions and discoveries in any and all foreign countries in its or their own name or names, or in our names, at its or their election, and we hereby assign, sell and set over to said ASSIGNEE, its successors, assigns or other legal representatives, all rights of priority, including any provisional applications, in and to said inventions and discoveries in all countries, including all applications claiming benefit of the filing date hereof, continuations, continuations-in-part, divisionals, reexaminations and reissue applications.

And we hereby agree for ourselves, our heirs, successors, assigns or other legal representatives to execute any and all papers, including applications for Letters Patent of any and all kinds and in any and all countries and to perform any and all acts which said ASSIGNEE, its successors, assigns or other legal representatives may deem necessary to secure thereto the rights herein assigned, sold and set over.

And we hereby represent and warrant that we have not granted any rights inconsistent with the rights granted herein.

Date: 04/16/, 2012

NADIR SHARAF

Date: \_\_\_\_\_, 2012

YU QIN

Date: 04/16/, 2012

RESHMA RATHOD

Date: 4/17, 2012

RICHARD J. HAMPO

**PATENT**

**REEL: 028147 FRAME: 0792**

**ASSIGNMENT**

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And we hereby represent and warrant that we have not granted any rights inconsistent with the rights granted herein.

Date: \_\_\_\_\_, 2012

\_\_\_\_\_  
NADIR SHARAF

Date: 4/10, 2012

\_\_\_\_\_  
YU QIN

Date: \_\_\_\_\_, 2012

\_\_\_\_\_  
RESHMA RATHOD

Date: \_\_\_\_\_, 2012

\_\_\_\_\_  
RICHARD J. HAMPO